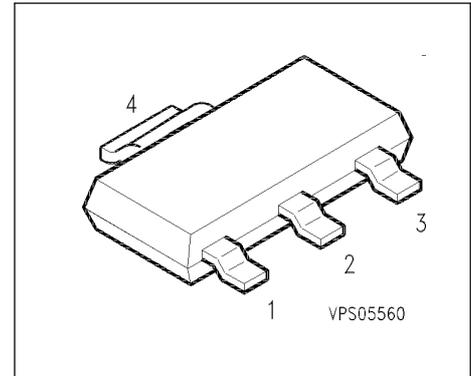


### SIPMOS® Small-Signal Transistor

- N channel
- Enhancement mode
- Avalanche rated
- $V_{GS(th)} = 2.1 \dots 4.0 \text{ V}$



Pin 1	Pin 2	Pin 3	Pin 4
G	D	S	D

Type	$V_{DS}$	$I_D$	$R_{DS(on)}$	Package	Marking	Ordering Code
BSP 320 S	60 V	2.9 A	0.12 $\Omega$	SOT-223		Q67000-S4001

### Maximum Ratings

Parameter	Symbol	Values	Unit
Continuous drain current $T_A = 25 \text{ }^\circ\text{C}$ $T_A = 100 \text{ }^\circ\text{C}$	$I_D$	2.9 1.85	A
DC drain current, pulsed $T_A = 25 \text{ }^\circ\text{C}$	$I_{Dpuls}$	11.6	
Avalanche energy, single pulse $I_D = 2.9 \text{ A}$ , $V_{DD} = 25 \text{ V}$ , $R_{GS} = 25 \text{ } \Omega$ $L = 14.3 \text{ mH}$ , $T_j = 25 \text{ }^\circ\text{C}$	$E_{AS}$	60	mJ
Avalanche energy, periodic limited by $T_{j(max)}$	$E_{AR}$	0.18	
Avalanche current, repetitive, limited by $T_{j(max)}$	$I_{AR}$	2.9	A
Reverse diode $dv/dt$ $I_S = 2.9 \text{ A}$ , $V_{DS} = 40 \text{ V}$ , $di/dt = 200 \text{ A}/\mu\text{s}$ $T_{jmax} = 150 \text{ }^\circ\text{C}$	$dv/dt$	6	KV/ $\mu\text{s}$
Gate source voltage	$V_{GS}$	$\pm 20$	V
Power dissipation $T_A = 25 \text{ }^\circ\text{C}$	$P_{tot}$	1.8	W

**Maximum Ratings**

Parameter	Symbol	Values	Unit
Chip or operating temperature	$T_j$	-55 ... + 150	°C
Storage temperature	$T_{stg}$	-55 ... + 150	
Thermal resistance, chip to ambient air <sup>1)</sup>	$R_{thJA}$	≤ 70	K/W
Thermal resistance, junction-soldering point <sup>1)</sup>	$R_{thJS}$	17	
IEC climatic category, DIN IEC 68-1		55 / 150 / 56	

1) Transistor on epoxy pcb 40 mm x 40 mm x 1,5 mm with 6 cm<sup>2</sup> copper area for drain connection

\*) MIL STD 883, Method 3015, Class 2

**Electrical Characteristics, at  $T_j = 25^\circ\text{C}$ , unless otherwise specified**

Parameter	Symbol	Values			Unit
		min.	typ.	max.	

**Static Characteristics**

Drain- source breakdown voltage $V_{GS} = 0 \text{ V}, I_D = 0.25 \text{ mA}, T_j = 25^\circ\text{C}$	$V_{(BR)DSS}$	60	-	-	V
Gate threshold voltage $V_{GS} = V_{DS}, I_D = 20 \mu\text{A}$	$V_{GS(th)}$	2.1	3	4	
Zero gate voltage drain current $V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}, T_j = -40^\circ\text{C}$ $V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}, T_j = 25^\circ\text{C}$ $V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}, T_j = 125^\circ\text{C}$	$I_{DSS}$	-	-	0.1	$\mu\text{A}$
		-	0.1	1	
		-	-	100	
Gate-source leakage current $V_{GS} = 20 \text{ V}, V_{DS} = 0 \text{ V}$	$I_{GSS}$	-	10	100	nA
Drain-Source on-state resistance $V_{GS} = 10 \text{ V}, I_D = 2.9 \text{ A}$	$R_{DS(on)}$	-	0.09	0.12	$\Omega$

**Electrical Characteristics, at  $T_j = 25^\circ\text{C}$ , unless otherwise specified**

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
<b>Dynamic Characteristics</b>					
Transconductance $V_{DS} \geq 2 \cdot I_D \cdot R_{DS(on)max}$ , $I_D = 2.9 \text{ A}$	$g_{fs}$	2.5	-	-	S
Input capacitance $V_{GS} = 0 \text{ V}$ , $V_{DS} = 25 \text{ V}$ , $f = 1 \text{ MHz}$	$C_{iss}$	-	275	340	pF
Output capacitance $V_{GS} = 0 \text{ V}$ , $V_{DS} = 25 \text{ V}$ , $f = 1 \text{ MHz}$	$C_{oss}$	-	90	120	
Reverse transfer capacitance $V_{GS} = 0 \text{ V}$ , $V_{DS} = 25 \text{ V}$ , $f = 1 \text{ MHz}$	$C_{rss}$	-	50	65	
Turn-on delay time $V_{DD} = 30 \text{ V}$ , $V_{GS} = 10 \text{ V}$ , $I_D = 2.9 \text{ A}$ $R_G = 33 \Omega$	$t_{d(on)}$	-	11	17	ns
Rise time $V_{DD} = 30 \text{ V}$ , $V_{GS} = 10 \text{ V}$ , $I_D = 2.9 \text{ A}$ $R_G = 33 \Omega$	$t_r$	-	25	40	
Turn-off delay time $V_{DD} = 30 \text{ V}$ , $V_{GS} = 10 \text{ V}$ , $I_D = 2.9 \text{ A}$ $R_G = 33 \Omega$	$t_{d(off)}$	-	25	40	
Fall time $V_{DD} = 30 \text{ V}$ , $V_{GS} = 10 \text{ V}$ , $I_D = 2.9 \text{ A}$ $R_G = 33 \Omega$	$t_f$	-	35	55	
Gate charge at threshold $V_{DD} = 40 \text{ V}$ , $I_D = 0.1 \text{ A}$ , $V_{GS} 0 \text{ to } 1 \text{ V}$	$Q_{g(th)}$	-	0.24	0.3	nC
Gate Charge at 7.0 V $V_{DD} = 40 \text{ V}$ , $I_D = 2.9 \text{ A}$ , $V_{GS} 0 \text{ to } 7 \text{ V}$	$Q_{g(7)}$	-	7.4	9.3	
Gate Charge total $V_{DD} = 40 \text{ V}$ , $I_D = 2.9 \text{ A}$ , $V_{GS} 0 \text{ to } 10 \text{ V}$	$Q_{g(total)}$	-	9.7	12	
Gate plateau voltage $V_{DS} = 15 \text{ V}$ , $I_D = 2.9 \text{ A}$	$V_{(plateau)}$	-	4.7	-	V

**Electrical Characteristics, at  $T_j = 25^\circ\text{C}$ , unless otherwise specified**

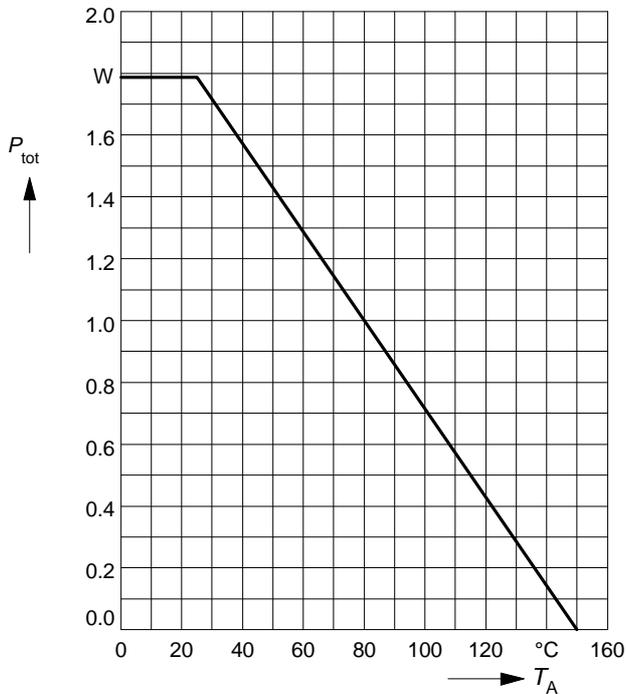
Parameter	Symbol	Values			Unit
		min.	typ.	max.	

**Reverse Diode**

Inverse diode continuous forward current $T_A = 25^\circ\text{C}$	$I_S$	-	-	2.9	A
Inverse diode direct current,pulsed $T_A = 25^\circ\text{C}$	$I_{SM}$	-	-	11.6	
Inverse diode forward voltage $V_{GS} = 0\text{ V}, I_F = 5.8\text{ A}$	$V_{SD}$	-	0.94	1.2	V
Reverse recovery time $V_R = 30\text{ V}, I_F = I_S, di_F/dt = 100\text{ A}/\mu\text{s}$	$t_{rr}$	-	45	56	ns
Reverse recovery charge $V_R = 30\text{ V}, I_F = I_S, di_F/dt = 100\text{ A}/\mu\text{s}$	$Q_{rr}$	-	0.08	0.12	$\mu\text{C}$

### Power dissipation

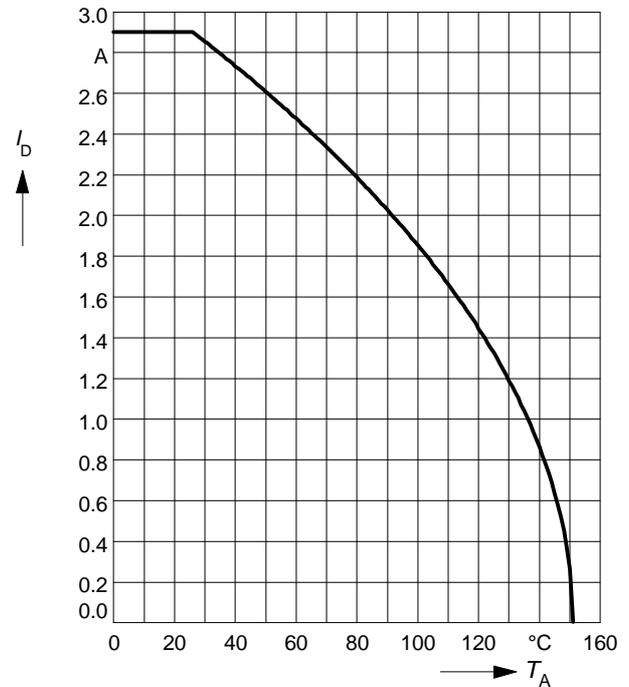
$$P_{\text{tot}} = f(T_A)$$



### Drain current

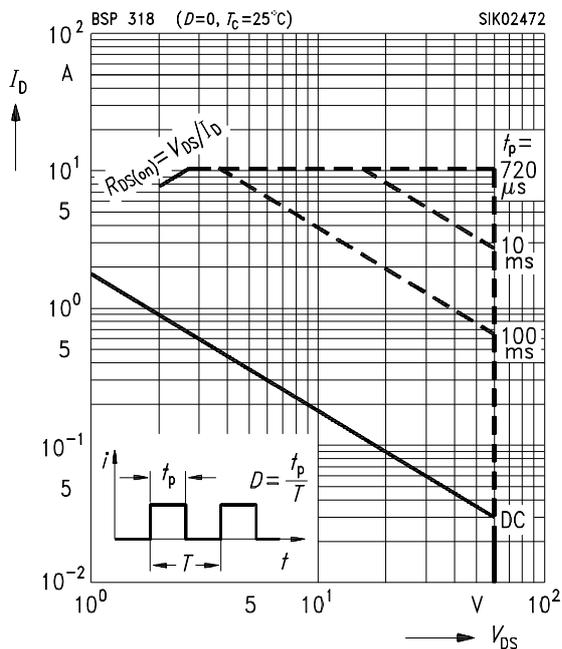
$$I_D = f(T_A)$$

parameter:  $V_{GS} \geq 10 \text{ V}$



### Safe operating area $I_D = f(V_{DS})$

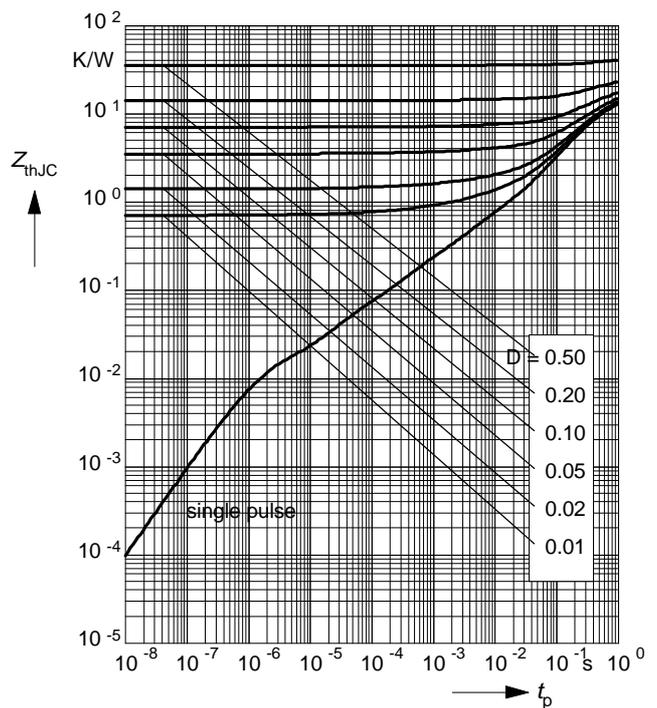
parameter:  $D = 0, T_C = 25^\circ\text{C}$



### Transient thermal impedance

$$Z_{\text{thJA}} = f(t_p)$$

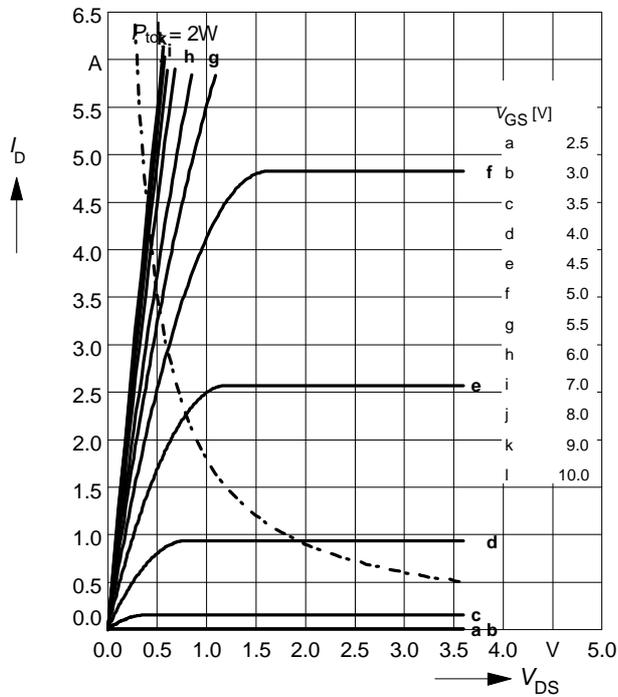
parameter:  $D = t_p / T$



### Typ. output characteristics

$$I_D = f(V_{DS})$$

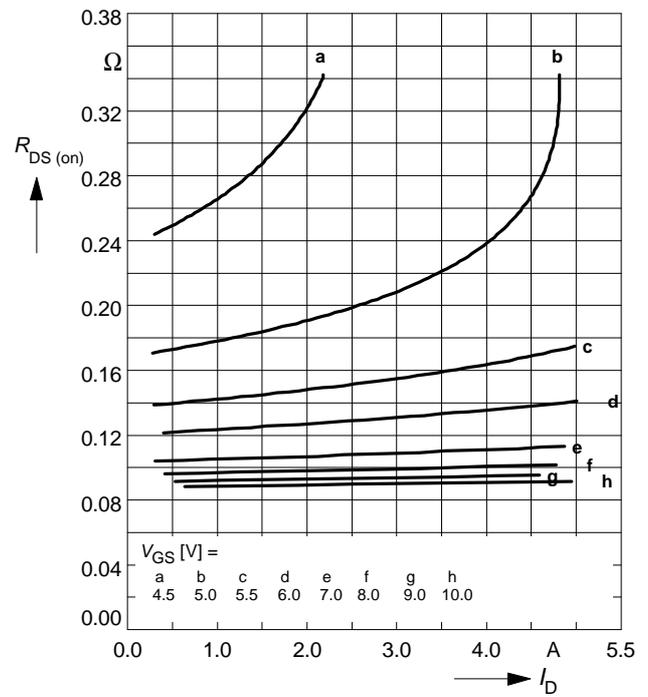
parameter:  $t_p = 80 \mu s$ ,  $T_j = 25^\circ C$



### Typ. drain-source on-resistance

$$R_{DS(on)} = f(I_D)$$

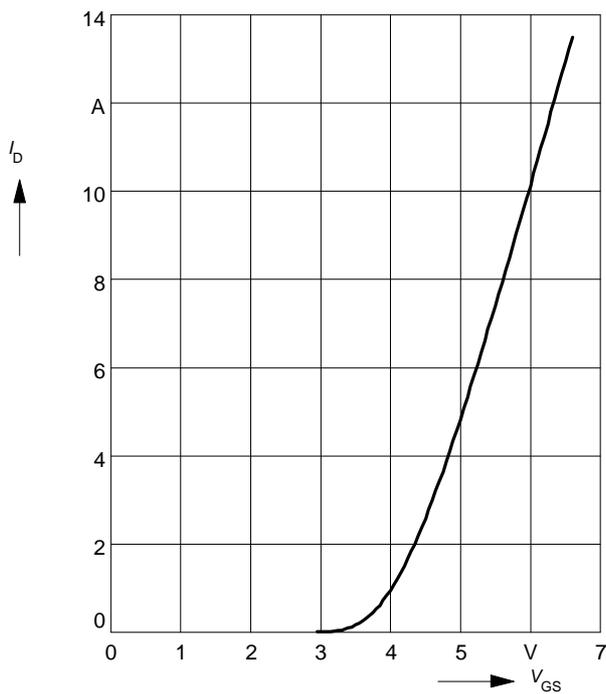
parameter:  $t_p = 80 \mu s$ ,  $T_j = 25^\circ C$



### Typ. transfer characteristics $I_D = f(V_{GS})$

parameter:  $t_p = 80 \mu s$

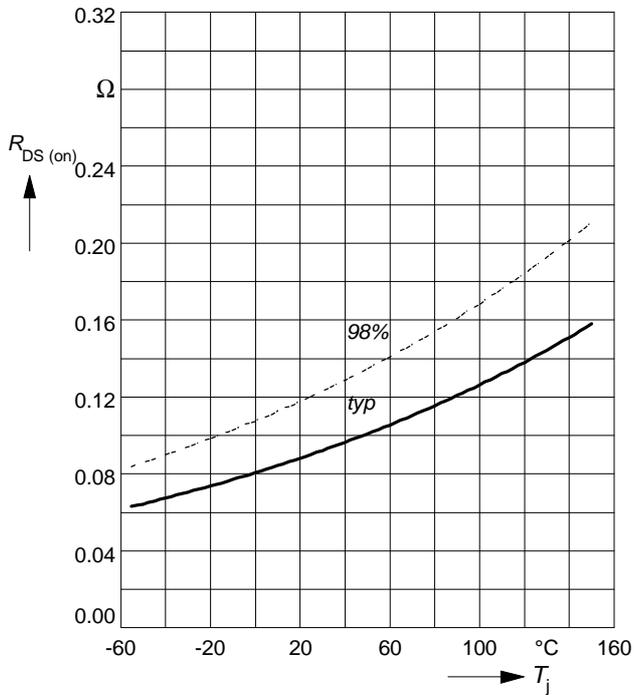
$$V_{DS} \geq 2 \times I_D \times R_{DS(on)max}$$



### Drain-source on-resistance

$$R_{DS(on)} = f(T_j)$$

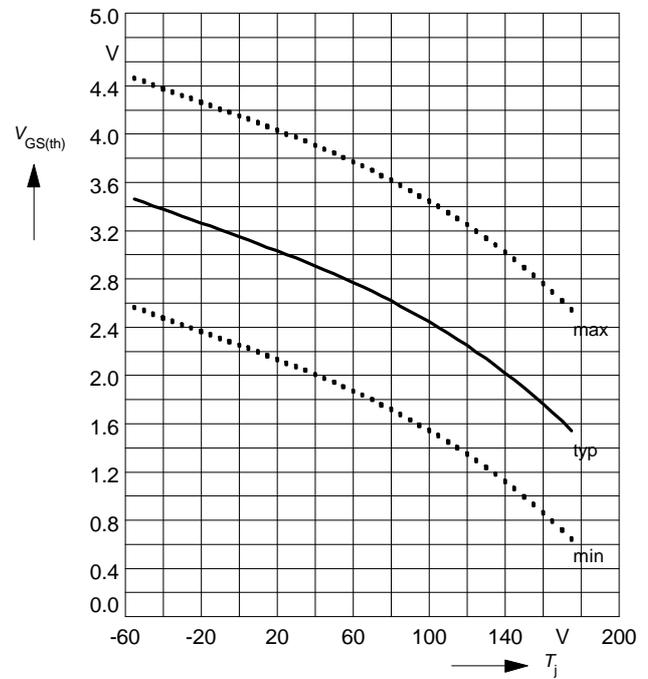
parameter:  $I_D = 2.9 \text{ A}$ ,  $V_{GS} = 10 \text{ V}$



### Gate threshold voltage

$$V_{GS(th)} = f(T_j)$$

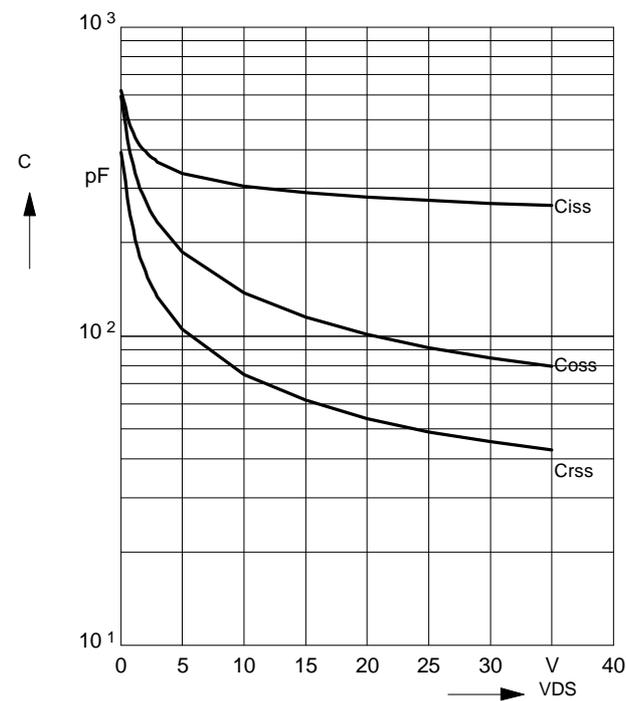
parameter:  $V_{GS} = V_{DS}$ ,  $I_D = 20 \mu\text{A}$



### Typ. capacitances

$$C = f(V_{DS})$$

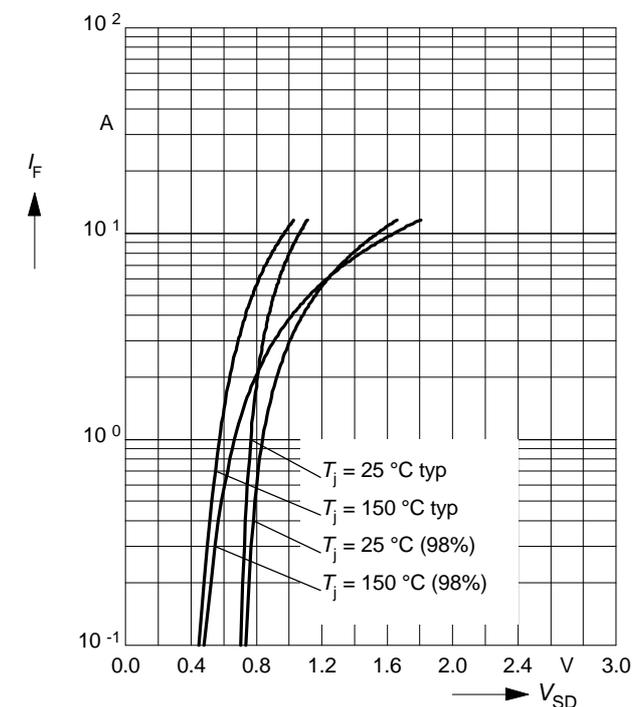
parameter:  $V_{GS} = 0\text{V}$ ,  $f = 1 \text{ MHz}$



### Forward characteristics of reverse diode

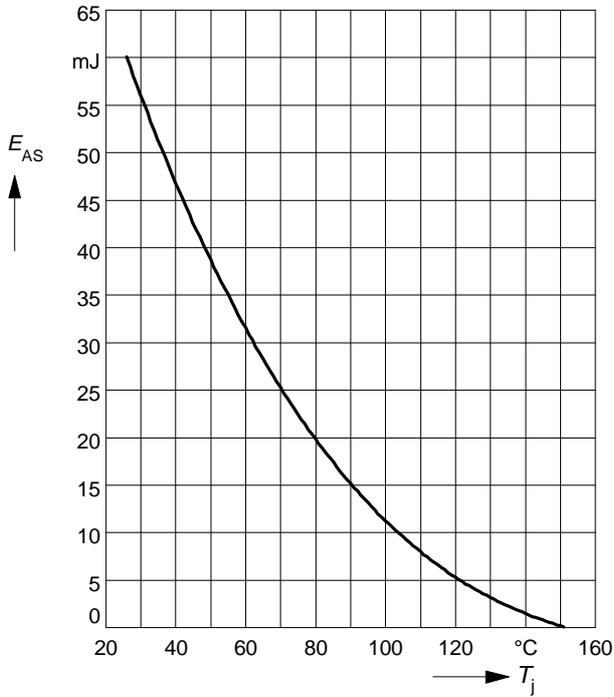
$$I_F = f(V_{SD})$$

parameter:  $T_j, t_p = 80 \mu\text{s}$



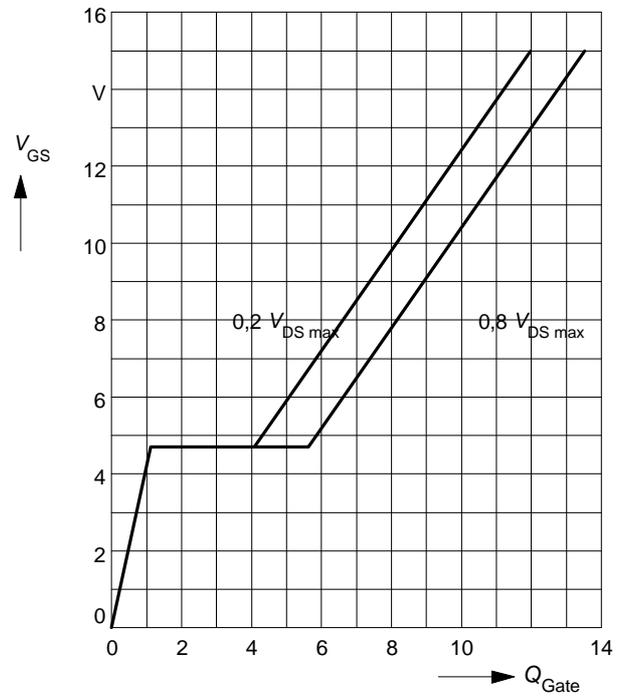
### Avalanche energy $E_{AS} = f(T_j)$

parameter:  $I_D = 2.9 \text{ A}$ ,  $V_{DD} = 25 \text{ V}$   
 $R_{GS} = 25 \text{ } \Omega$ ,  $L = 14.3 \text{ mH}$



### Typ. gate charge $V_{GS} = f(Q_{Gate})$

parameter:  $I_{D \text{ puls}} = 3 \text{ A}$



### Drain-source breakdown voltage $V_{(BR)DSS} = f(T_j)$

$V_{(BR)DSS} = f(T_j)$

